## STA2 Datasheet 64-Channel CMOS Analog Switch IC

6 April 2015

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# Preliminary



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## **GENERAL DESCRIPTION**

The STA IC is a monolithic CMOS device containing 64 independently selectable switches. These switches are fabricated with an advanced submicron CMOS process that provides low power dissipation, low on resistance, low leakage currents, and high signal bandwidth. The STA IC is designed to operate in 3.3V for digital circuits and 5V for analog switches. Each switch can operate with a wide input and output voltage range. The off-leakage current is only 30nA at room temperature of 25°C.

All digital inputs have 0.8-V to 2.4-V input noise margin to ensure TTL/CMOS-logic compatibility when using a 3.3-V power supply.

#### **FEATURE**

3.3V logic-compatible input ( $V_{IH}$ =2.4V,  $V_{IL}$ =0.8V) Dual supply operation: 3.3V for digital, 5V for analog. Analog signal frequency: DC-to-1MHz Low on-resistance: 1 $\Omega$  (@typ) Wide range analog input from 0V to 5V Chip-ID programmable with OTP memory Multi-channel switch control Switching control using CMOS IF command 180-pin FBGA package

## **APPLICATIONS**

Data-acquisition systems Mechanical reed-relay replacement Communication systems

## FUNCTIONAL DIAGRAM

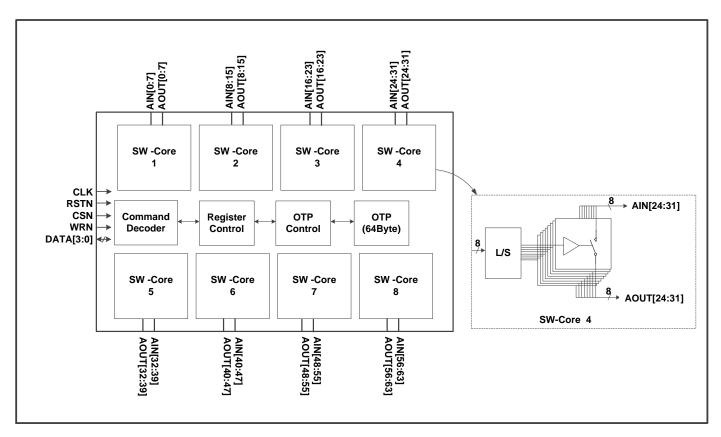


Figure 1. Functional Diagram



LEO LSI 2 DS\_STA2\_V1.3

## ABSOLUTE MAXIMUM RATINGS\_\_\_\_\_

#### (All Voltages Referenced to GND, Unless Otherwise Noted.)

AVDD (for Analog Switch)	0.3V to +6V
DVDD (for Digital Control)	0.3V to +4.5V
Voltage at any digital pin	0.3V to +4.5V
Voltage at any analog pin	0.3V to +6V
Continuous current into any terminal	50mA
Peak current into analog switch I/O	100mA
(current pulse with 1ms and 10% duty of	cycle)

Operating temperature range	40°C to +85°C
Storage temperature range	65°C to +125°C
Junction temperature	+150°C
ESD protection on all pins (HBM, MI	M)≥2kV, 200V

Notice: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at those or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS\_\_\_\_\_

AVDD=5.0V, AVSS=0V, DVDD=3.3V, DVSS=0V, and TA = +25°C, unless otherwise noted.

PARAMETER		CVMPOL	SYMBOL CONDITION		VALUE		
		STMBOL CONDITION		MIN	TYP	MAX	UNIT
POWER SU	PPLIES						
Analog Supp	oly Voltage	AVDD		4.5	5	5.5	V
Digital Supp	ly Voltage	DVDD		3.0	3.3	3.6	V
Analog Grou	ınd Voltage	AVSS		-	0	-	V
Digital Ground Voltage		DVSS		-	0	-	V
ANALOG S	WITCH						
Signal	Input Range	V <sub>AIN</sub>		0		AVDD	V
Range Output Range		V <sub>AOUT</sub>		0		AVDD	V
Channel On Current		I <sub>CH_ON</sub>	AVDD=5V, V <sub>AIN</sub> =0V or 5V			50	mA
Switch On-resistance		R <sub>ON</sub>	V <sub>AIN</sub> =0V to AVDD , I <sub>CH_ON</sub> =-1mA		1	3	Ω
	Source Off Leakage Current	I <sub>S_OFF</sub>	AVDD=5V, V <sub>AIN</sub> =5, V <sub>AOUT</sub> =0V		0.05	1	uA
Leakage Current	Drain Off Leakage Current	I <sub>D_OFF</sub>	AVDD=5V, V <sub>AIN</sub> =0V, V <sub>AOUT</sub> =5V		0.05	1	uA
	Channel On Leakage Current	I <sub>CH_OFF</sub>	AVDD=5V, V <sub>AIN</sub> =0V or 5V		0.05	1	uA



LEO LSI 3 DS\_STA2\_V1.3

## ELECTRICAL CHARACTERISTICS (Continued)

AVDD=5.0V, AVSS=0V, DVDD=3.3V, DVSS=0V, and TA = +25°C, unless otherwise noted.

DADA	PARAMETER		SYMBOL CONDITION		VALUE			
FARAINETER		SYMBOL CONDITION		MIN	TYP	MAX	UNIT	
DIGITAL I/O								
Logic Input	Input High	V <sub>IH</sub>		0.7* DVDD			V	
Voltage	Input Low	V <sub>IL</sub>				0.3* DVDD	V	
Logic Input	Input High	I <sub>IH</sub>		-1		1	uA	
Current	Input Low	I <sub>IL</sub>		-1		1	uA	
SWITCH DYNA	AMIC CHARACTE	RISTICS						
Switching	Turn ON Time	t <sub>ON</sub>	Clock base (calculate for special condition)		175		ns	
Time	Turn OFF Time	toff			235		ns	
	Input Off- Capacitance	C <sub>AIN_OFF</sub>			150		pF	
Capacitance	Output Off- Capacitance	C <sub>AOUT_OFF</sub>			150		pF	
	Output On- Capacitance	C <sub>AOUT_ON</sub>			300		pF	
Off-Isolation			No Load, f <sub>SW</sub> =1MHz	-16			dB	
Channel-to-Ch	annel Crosstalk		No Load, f <sub>SW</sub> =1MHz	-41			dB	
POWER CONS	SUMPTION							
Analog	Static	I <sub>AVDD_ST</sub>	AVDD=5V			1	uA	
Operating Current (AVDD)	Dynamic	I <sub>AVDD_DYN</sub>	AVDD=5V, f <sub>SW</sub> =1.25MHz (Note1), All switch On/Off operating simultaneously			50	mA	
Digital	Static	I <sub>DVDD_ST</sub>	DVDD=3.3V			1	uA	
Digital Operating Current (DVDD) Otalic Otalic Otalic Otalic		I <sub>DVDD_DYN</sub>	DVDD=3.3V, f <sub>CLK</sub> =10MHz (Note1), Combined operation of Reset, Group-On and DUT-Reject			400	uA	

 $oldsymbol{Note1}$ : The  $f_{CLK}$  is the frequency of digital signal CLK.

When the  $f_{CLK}$  is 10MHz, the maximum switching frequency ( $f_{SW}$ ) is 1.25MHZ (1-clock command).



LEO LSI 4 DS\_STA2\_V1.3

## TIMING CHARACTERISTICS\_\_\_\_\_

AVDD=5.0V, AVSS=0V, DVDD=3.3V, DVSS=0V, and TA = +25°C, unless otherwise noted.

PARAMETER	CVMDOL	CONDITION		UNIT			
PARAMETER	SYMBOL CONDITION		MIN	TYP	MAX		
DIGITAL I/O SIGNALS							
CLK Period	t <sub>PERIOD</sub>				20	ns	
DATA to CLK Setup Time	t <sub>DS</sub>		10			ns	
DATA to CLK Hold Time	t <sub>DH</sub>		5			ns	
CSN to CLK Setup Time	t <sub>CS</sub>		10			ns	
CSN to CLK Hold Time	t <sub>CH</sub>		5			ns	
WRN to CLK Setup Time	t <sub>WS</sub>		10			ns	
WRN to CLK Hold Time	t <sub>WH</sub>		5			ns	
POWER AND RESET SEQUENC	E						
Power-up Period	t <sub>PU</sub>		500			us	
Power-down Period	t <sub>PD</sub>		500			us	
Power-on Reset Time	t <sub>RST</sub>		2			us	
Chip-ID Read Routine Time	t <sub>IDRD</sub>		2			us	
SWITCH ON/OFF TIMING DIAGE	RAM						
Switch Control Enable Time	t <sub>SWEN</sub>		1			us	
1-Clock Command Control Time	t <sub>SW1</sub>				3	cycle	
2-Clock Command Control Time	t SW2				6	cycle	

#### Timing Diagram of Digital I/O Signals

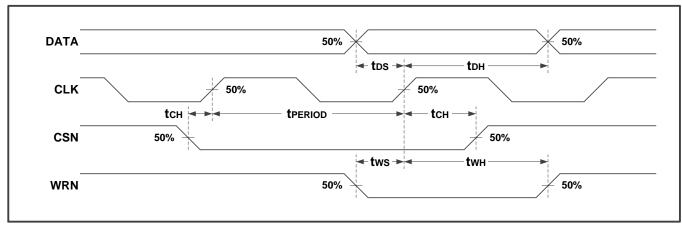


Figure 2. Timing Diagram of Digital Signals

#### Power and Reset sequence

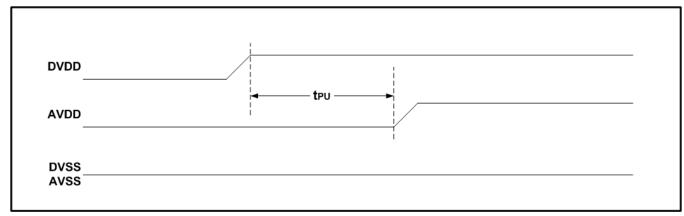


Figure 3. Power-up Sequence

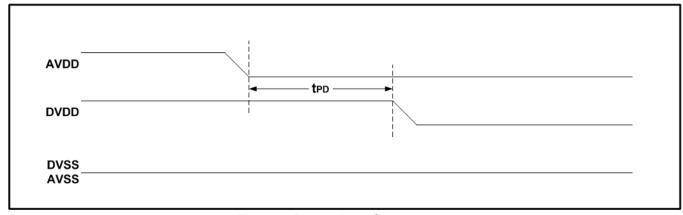


Figure 4. Power-down Sequence

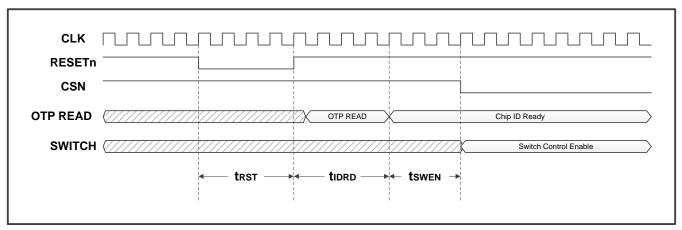


Figure 5. Reset and Stand-by Sequence

#### Switch On/Off Timing Diagram

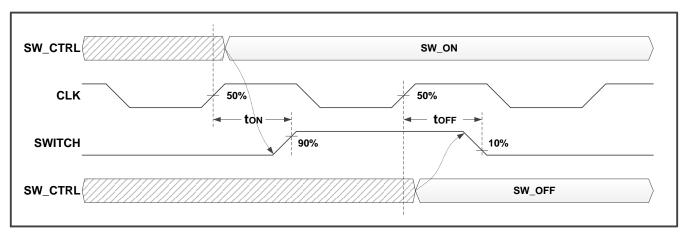


Figure 6. Switch On/Off Timing Diagram

## PIN MAPPING TABLE\_\_\_\_\_

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	
Α	DATA[2]	DATA[1]	CLK	WRN	VPP	AOUT[60]	AIN[60]	AOUT[56]	AIN[56]	AOUT[52]	AIN[55]	AIN[54]	AIN[53]	AIN[52]	A
В	DATA[3]	DATA[0]	PAGE_UP	CSN	DVSS	AOUT[61]	AIN[61]	AOUT[57]	AIN[57]	AOUT[53]	AOUT[51]	AOUT[50]	AOUT[49]	AOUT[48]	В
С	DVDD	DVSS	TEST_IN	RSTN	DVDD	AOUT[62]	AIN[62]	AOUT[58]	AIN[58]	AOUT[54]	AIN[51]	AIN[50]	AIN[49]	AIN[48]	С
D	AVSS	AVDD	AVSS	AVSS	DVSS	AOUT[63]	AIN[63]	AOUT[59]	AIN[59]	AOUT[55]	AVSS	AVSS	AVDD	AVSS	D
E	AIN[0]	AIN[1]	AIN[2]	AIN[3]	AVDD	AVSS	AVSS	AVDD	AVSS	AVDD	AOUT[47]	AOUT[46]	AOUT[45]	AOUT[44]	E
F	AOUT[0]	AOUT[1]	AOUT[2]	AOUT[3]	AVSS		•			AVSS	AIN[47]	AIN[46]	AIN[45]	AIN[44]	F
G	AIN[4]	AIN[5]	AIN[6]	AIN[7]	AVDD		_	9002		AVSS	AOUT[43]	AOUT[42]	AOUT[41]	AOUT[40]	G
Н	AOUT[4]	AOUT[5]	AOUT[6]	AOUT[7]	AVSS			A2 View)		AVDD	AIN[43]	AIN[42]	AIN[41]	AIN[40]	н
J	AIN[8]	AIN[9]	AIN[10]	AIN[11]	AVSS					AVSS	AOUT[39]	AOUT[38]	AOUT[37]	AOUT[36]	J
ĸ	AOUT[8]	AOUT[9]	AOUT[10]	AOUT[11]	AVDD	AVSS	AVDD	AVSS	AVSS	AVDD	AIN[39]	AIN[38]	AIN[37]	AIN[36]	к
L	AIN[12]	AIN[13]	AIN[14]	AIN[15]	AOUT[19]	AIN[23]	AOUT[23]	AIN[27]	AOUT[27]	AIN[31]	AOUT[31]	AVSS	AIN[35]	AOUT[35]	L
М	AOUT[12]	AOUT[13]	AOUT[14]	AOUT[15]	AOUT[18]	AIN[22]	AOUT[22]	AIN[26]	AOUT[26]	AIN[30]	AOUT[30]	AVSS	AIN[34]	AOUT[34]	м
N	AVSS	AVDD	AVSS	AVSS	AOUT[17]	AIN[21]	AOUT[21]	AIN[25]	AOUT[25]	AIN[29]	AOUT[29]	AVDD	AIN[33]	AOUT[33]	N
Р	AIN[16]	AIN[17]	AIN[18]	AIN[19]	AOUT[16]	AIN[20]	AOUT[20]	AIN[24]	AOUT[24]	AIN[28]	AOUT[28]	AVSS	AIN[32]	AOUT[32]	Р
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	

## PIN DESCRIPTIONS\_\_\_\_\_

PIN NAME	I/O	Descriptions		
CLK	DI	System clock		
RSTN	DI	System reset. Active Low		
CSN	DI	Chip select. Active Low		
WRN	DI	Data write enable. Active Low		
DATA[3:0]	DIO	Data bus		
TEST_IN	DI	Tied to GND in Normal mode		
PAGE_UP	DI	Tied to GND in Normal mode		
VPP	PWR	R Tied to GND in Normal mode		
AIN[63:0]	Al	Analog switch input		
AOUT[63:0]	AO	Analog switch output		
AVDD	PWR	Analog Power		
AVSS	GND	Analog Ground		
DVDD	PWR	Digital Power		
DVSS	GND	Digital Ground		

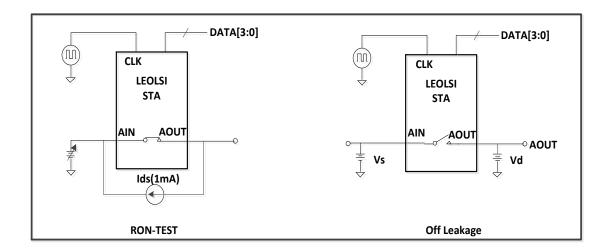
Al: analog input Dl: digital Input PWR: power AO: analog output
DIO: digital Input / Output

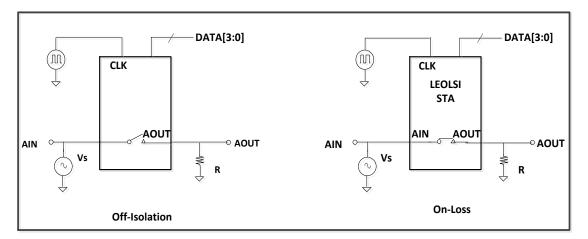
VR: power GND: ground



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## TEST CIRCUITS\_





Off isolation=20log(V<sub>AOUT</sub>/V<sub>AIN</sub>), On Loss=20log(V<sub>AOUT</sub>/V<sub>AIN</sub>)

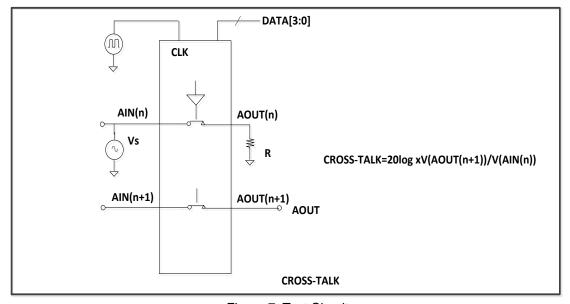
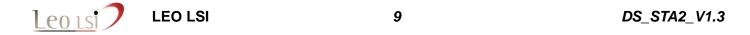
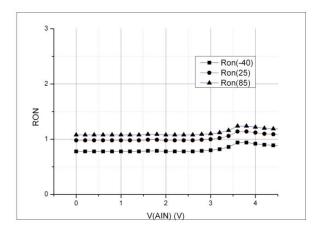


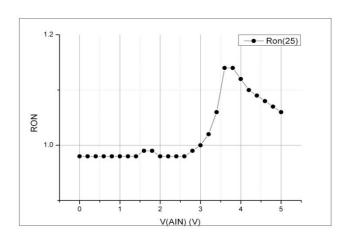
Figure 7. Test Circuits



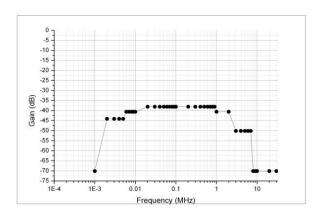
## **TEST RESULTS**



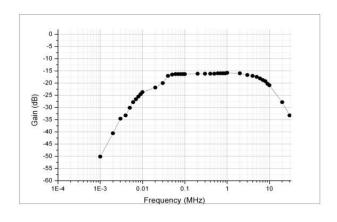
On-resistance vs. vain



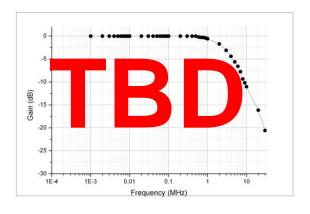
On-resistance(room temp) vs. vain



Cross talk vs. Frequency



Isolation vs. Frequency



On Loss vs. Frequency

Figure 8. Test Results

#### **DETAIL DESCRIPTIONS**

#### **Definitions**

The STA IC consists of 8 cores which consist of 8 switches, hence it has 64 switches. The device provides one Chip-ID and it can be programmed in internal OTP memory. On the other hand, the eight Core-IDs are fixed in the device. The internal switch structure is shown in Figure 9. The Channel-ID is implicated in user defined commands interpreted in Digital Interface section.

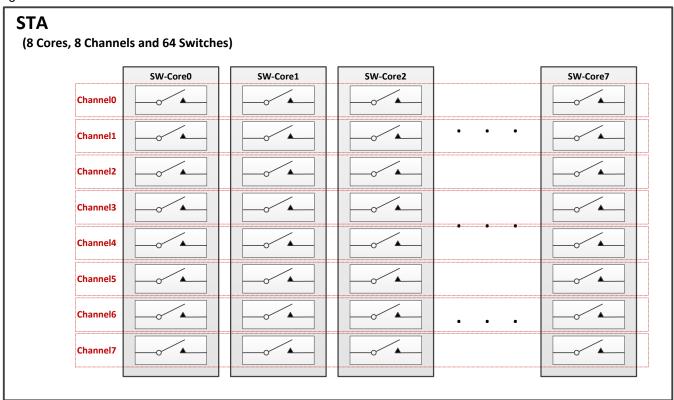


Figure 9. STA IC Internal Switch Structure and Definitions - Cores and Channels

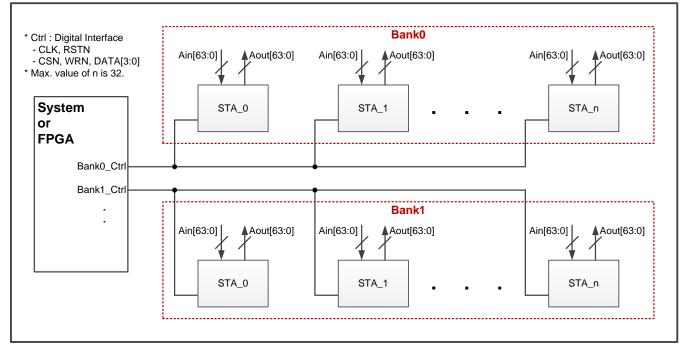


Figure 10. STA IC Application Structure and Definitions - Banks and Controls



LEO LSI 11 DS\_STA2\_V1.3

## 64-Channel CMOS Analog Switches

In system application, two or more STA ICs can be controlled by the same digital interface - control and data signals such as CLK, RESETN, CSN, WRN and DATA[3:0] shown in Figure 10 and these STA IC network can be called as 'bank'. Because the Chip-ID is assigned in 5-bit address, the maximum number of STA IC in one bank is 32. Similarly, the Core-ID is assigned in 3-bit address hence 8 Cores are in one STA IC. The user can not apply the Chip-ID and the Core-ID to 1-clock command but to 2-clock command. Refer to Figure 12 and 13.

#### - Bank

The bank means STA network connected by the same digital interface - control and data signals such as CLK, RESETN, CSN, WRN and DATA[3:0]. Refer to the Figure 10.

#### - Reject

The individual switch control logic can be rejected from all commands. After entering reject state in which the switch is off, no command alters on/off state of rejected switch except the command 'INITIAL\_ALL', 'CANCEL\_REJECT' and external RSTN.

#### Digital Interface

#### 1-Clock Command

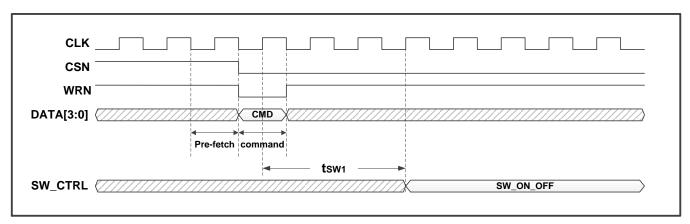


Figure 11. 1-Clock Command Control Timing Diagram

The 1-clock command is applied to all cores and all switches. Furthermore, this command is applied to all STA ICs in the same bank. The 'CMD' in Figure 11 means command which defines following modes:

Command	Value	Function
NORMAL	0x0	Returns to normal mode from Load mode (release all chip selection)
LOAD_ALL	0x1	Selects all chips to load(apply) the same commands
VIRTUAL	0x2	Programming mode for test
CLEAR_ALL	0x3	Makes all switches off
ENABLE_ALL	0x4	Makes all switches on
INITIAL_ALL	0x5	Initializes all switches releasing reject condition and making them on

#### - 2-Clock Command

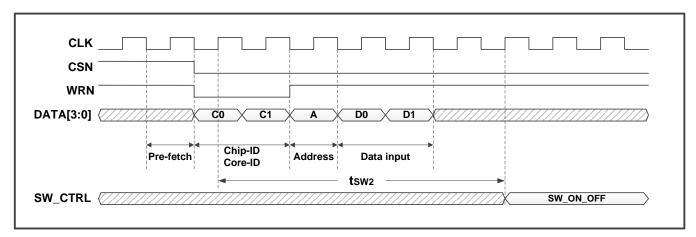


Figure 12. 2-Clock Command Control Timing Diagram

The '2-clock command' can control 8 Cores individually as well as simultaneously. Especially, the case of simultaneous 8 Core control can explain Channel-level switch control and it means that the users do not access Channel-ID directly.

In 2-clock command protocol, the signal DATA[3:0] can represent several items 'C0', 'C1', 'A', 'D0' and 'D1' shown in Figure 12 and these can be interpreted like as Figure 13.

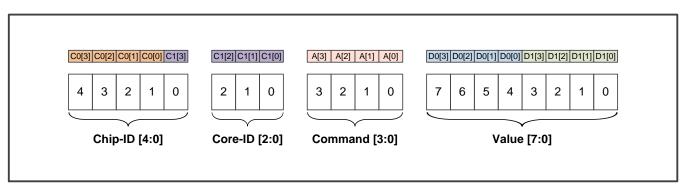


Figure 13. Interpretation of DATA[3:0] Signals in 2-Clock Command

The 'C0' and 'C1' are Chip-ID and Core-ID items and the address 'A' defines switch control Command. The Data 'D0' and 'D1' means the next state Value of 8 individual switches.

The 2-Clock command has three types of control.

- CHL(Chip-level) : applied to all chips in the same bank (both Chip-ID and Core-ID are ignored)
- CRL(Core-level) : applied to all cores of selected chip (Chip-ID is referred but Core-ID is ignored)
- SWL(Switch-level): applied to selected switches of selected core (both Chip-ID and Core-ID are referred)

When the MSB of Command[3:0] is low, the Value[7:0] is applied to all Cores. Otherwise, the MSB of Command[3:0] is high, the Value[7:0] is applied to one Core selected by Core-ID[2:0].

## 64-Channel CMOS Analog Switches

The detail 2-Clock commands are given below.

Command	Value	Function	Remark
AND_CRL	0x0	Next switch status are produced by bitwise AND operation between current switch status and Data[7:0]. Applied to all cores of the selected chip.	CRL
OR_CRL	0x1	Next switch status are produced by bitwise OR operation between current switch status and Data[7:0] ].  Applied to all cores of the selected chip.	CRL
DIRECT_CRL	0x2	Next switch status are produced by Data[7:0] directly.  Applied to all cores of the selected chip.	CRL
DIRECT_CHL	0x3	Next switch status are produced by Data[7:0] directly.  Applied to all cores of all chips in the same bank.	CHL
REJECT_CRL	0x4	Reject all switches of selected core by bitwise AND operation between current core reject status and Data[7:0].	CRL
-	0x5	Reserved	-
-	0x6	Reserved	-
-	0x7	Reserved	
AND_SWL	0x8	Next switch status are produced by bitwise AND operation between current switch status and Data[7:0]. Applied to the selected core.	SWL
OR_SWL	0x9	Next switch status are produced by bitwise OR operation between current switch status and Data[7:0].  Applied to the selected core.	SWL
DIRECT_SWL	0xa	Next switch status are produced by Data[7:0] directly. Applied to the selected core.	SWL
-	0xb	Reserved	-
REJECT_SWL	0xc	Reject selected switch by bitwise AND operation between current switch reject status and Data[7:0]	SWL
CANCEL_RJT	0xd	Cancel all switch-reject of selected core	-
-	0xe	Reserved	-
-	0xf	Reserved	-

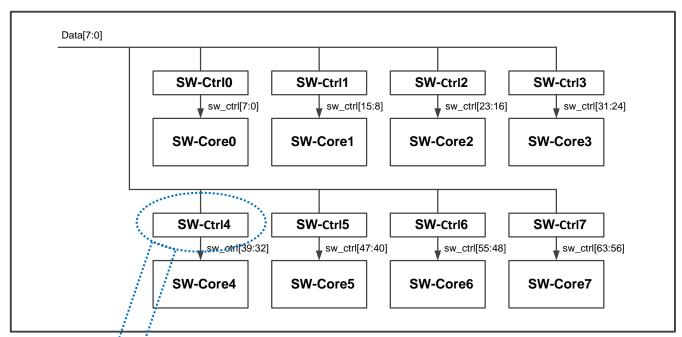


Figure 14. Switch Control Structure for 2-Clock Command

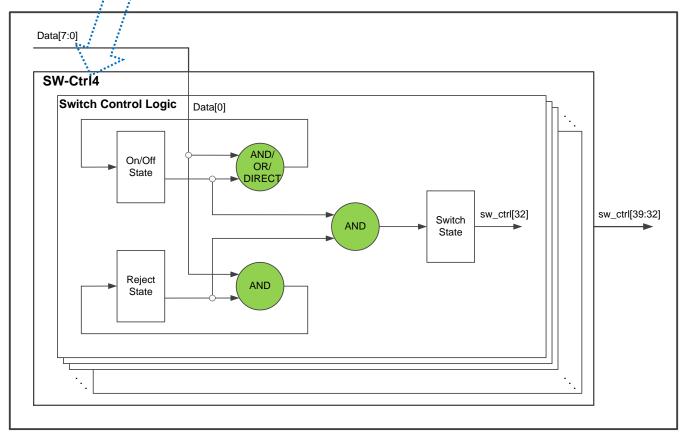


Figure 15. Basic Concept of 2-Clock Command Switch Control

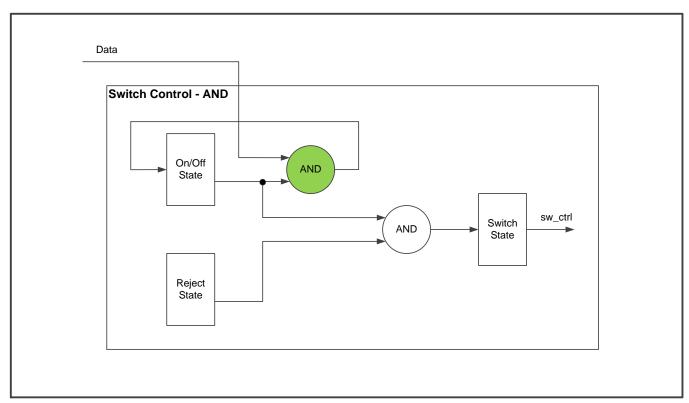


Figure 16. 2-Clock Command Switch Control - AND

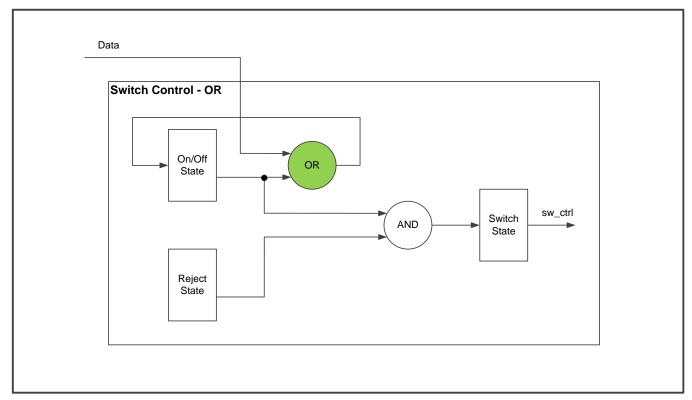


Figure 17. 2-Clock Command Switch Control - OR

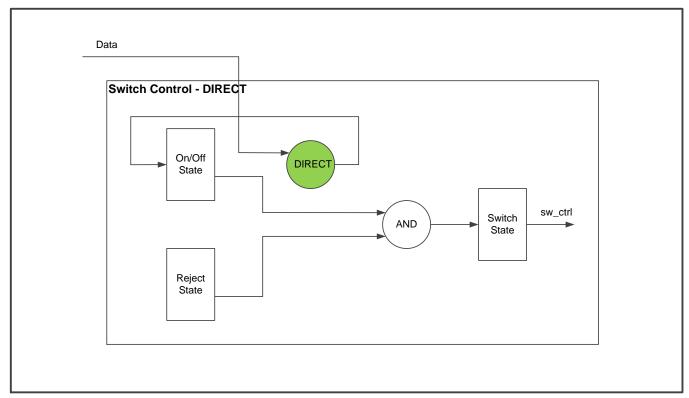


Figure 18. 2-Clock Command Switch Control - DIRECT

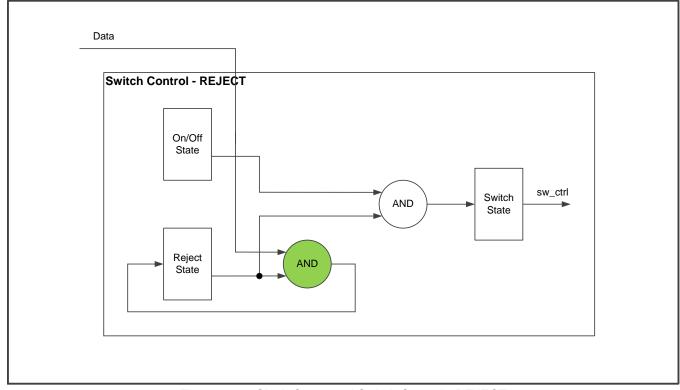


Figure 19. 2-Clock Command Switch Control - REJECT

## **APPLICATION EXAMPLE**

The STA IC receives serial input data synchronized with a clock signal.

Most of all, to achieve maximum control speed in PCB, simulation using IBIS model should be carried out.

- 1. TEST\_IN, PAGE\_UP and VPP pins should be connected to ground through 20-k $\Omega$  (pull-down) resistor.
- 2. CSN pin should be connected to digital power through 20-k $\Omega$  (pull-up) resistor.
- 3. To guarantee the control speed, any resistor or capacitor should not be connected to CLK and DATA pins.
- 4. 10uF and 0.1uF decoupling capacitors should be connected to between AVDD and AVSS, and the same capacitors to between DVSS and DVSS.

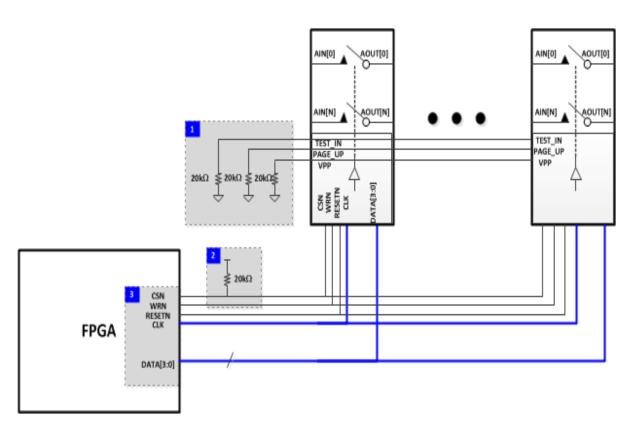
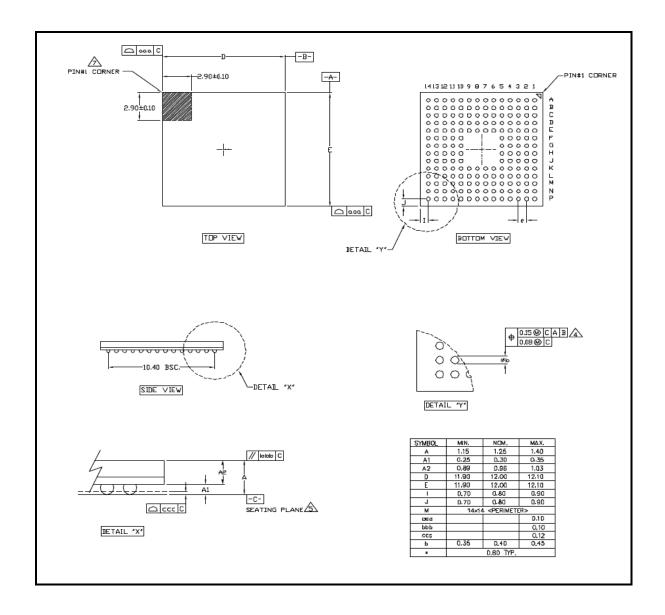


Figure 20. Application Example of PCB design

## PACKAGE INFORMATION



## **REVISION HISTORY\_**

Revision	Date	Description
0.0	2012-06	Initial draft
1.0	2013-11	Revised format
1.1	2014-03	Gain loss graph in figure 8 was changed as TBD.
1.2	2014-06	AVSS power up sequence
1.3	2015-04	Decoupling capacitors for AVDD-AVSS and DVDD-DVSS

## DOCUMENT INFORMATION

File name: STA2 Datasheet

Product code: STA2

Product description: Analog Switch IC

Document revision: 1.3 Revision date: 2015-04



The world is driven by analog

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